

# Computer Interface for Electroluminescence (EL)

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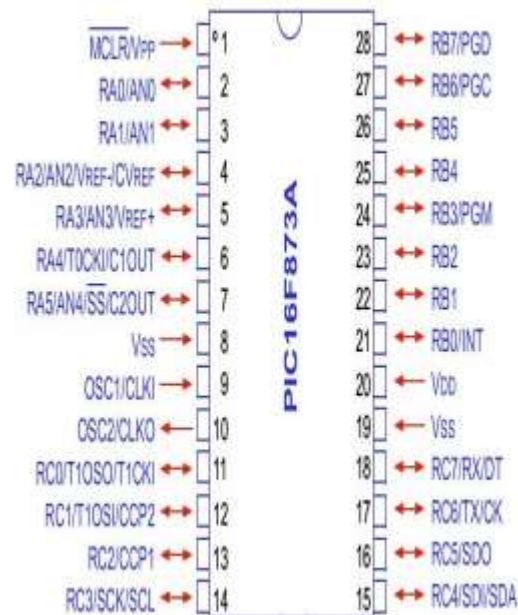
**Abstract:** The goal of Computer aided device start from the physical description of integrated circuit devices, considering both the physical configuration and related device properties and build the link between the broad range of physics and electrical behavior models that support circuit design. Physics-based modeling of devices, is distributed and lumped form is an essential part of the IC process development. It seeks to quantify the underlying understanding of the technology and abstract that knowledge to the device design level, including extraction of the key parameters that support circuit design and statistical metrology [1][2]. IC development for more than a quarter-century has been dominated by the MOS technology. In the 1970s and 1980s NMOS was favored owing to speed and area advantages, coupled with technology limitations and concerns related to isolation, parasitic effects and process complexity. During that era of NMOS-dominated LSI and the emergence of VLSI, the fundamental scaling laws of MOS technology were codified and broadly applied [3]. It was also during this period that Computer Aided Device reached maturity in terms of realizing robust process modeling (primarily one-dimensional) which then became an integral technology design tool, used universally across the industry [4]. At the same time device simulation, dominantly two-dimensional owing to the nature of MOS devices, became the work-horse of technologists in the design and scaling of devices [5]. The transition from NMOS to CMOS technology resulted in the necessity of tightly coupled and fully 2D simulators for process and device simulations [6][7].

**Keywords:** Computer interface, interfacing, computer aided device.

## 1. INTRODUCTION

In computer science, an interface is the point of interaction with software, or computer hardware, or with peripheral devices such as a computer monitor or a keyboard. Some computer interfaces such as a touch screen can send and receive data, while others such as a mouse or microphone can only send data [8]. A hardware interfaces exist in computing systems between many of the components such as the various buses, storage devices, other I/O devices, etc. A hardware interface is described by the mechanical, electrical and logical signals at the interface and the protocol for sequencing them (sometimes called signaling). A standard interface, such as SCSI decouples the design and introduction of computing hardware, such as I/O devices, from the design and introduction of other components of a computing system, thereby allowing users and manufacturer’s greater flexibility in the implementation of computing systems. Hardware interfaces can be parallel where performance is important or serial where distance is important [9]. A computer network, also referred to as just a network consists of two or more computers and typically other devices as well (such as printers, external hard drives, modems and routers), that are linked together so that they can communicate with each other and thereby exchange commands and share data, hardware and other resources. The devices on a network are referred to as nodes. They are analogous to the knots in nets that have traditionally been used by fishermen and others. Nodes can be connected using any of various types of media, including twisted pair copper wire cable, optical fiber cable, coaxial cable and radio waves. And they can be arranged according to several basic topologies (i.e., layouts), including bus (in which all nodes are connected along a single cable), star (all nodes are connected to a central node), tree (nodes successively branch off from other nodes) and ring

## 2. DESCRIPTION OF HARDWARE USED



Pin Description of PIC16F873A microcontroller

Pin No.	Pin Name	Description
1	MCLR/VPP	Master Clear (input) or programming voltage

		(output). This pin is active low
2	RA0/ANO	Digital I/O. Analog input 0.
3	RA1/AN1	Digital I/O. Analog input 1.
4	RA2/AN2/VREF- /CVREF	Digital I/O. Analog input 2. A/D reference voltage (Low) input. Comparator VREF output.
5	RA3/AN3/VREF+	Digital I/O. Analog input 3. A/D reference voltage (High) input.
6	RA4/TOCKI/C1OUT	Digital I/O- Open –Drain when configured as output.
7	RA5/AN4/SS/C2OUT	Digital I/O. Analog Input 4. SPI Slave selects input. Comparator 2 output.
8	VSS	Ground reference for logic and I/O Pins.
9	OSC1/CLK1	Oscillator Crystal or external clock input. Oscillator crystal input or external clock source input
10	OSC2/CLKO	Oscillator Crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode.
11	RCO/T1OSO/TICKI	Digital I/O. Timer1 oscillator output. Timer1 external clock input.
12	RC1/T1OSI/CCP2	Digital I/O. Timer1 oscillator input. Capture2 input, compare2 output, PWM2 output.
13	RC2/CCP1	Digital I/O. Capture1 input, compare 1 output, PWM 1 output.
14	RC3/SCK/SCL	Digital I/O. Synchronous serial Clock input/output for SPI mode.

		Synchronous serial Clock input/output for I <sup>2</sup> C mode.
15	RC4/SDI/SDA	Digital I/O. SPI data in. I <sup>2</sup> C data I/O.
16	RC5/SDO	Digital I/O. SPI data out.
17	RC6/TX/CK	Digital I/O. USART asynchronous transmit. USART1 synchronous clock.
18	RC7/RX/DT	Digital I/O. USART asynchronous receive. USART synchronous data.
19	VSS	Ground reference for logic and I/O Pins.
20	VDD	Positive Supply for logic and I/O Pins.
21	RBO/INT	Digital I/O. External Interrupts
22	RB1	Digital I/O.
23	RB2	Digital I/O.
24	RB3/PGM	Digital I/O. Low- voltage (single-supply) ICSP programming enable pin.
25	RB4	Digital I/O.
26	RB5	Digital I/O.
27	RB6/PGC	Digital I/O. In-circuit debugger and ICSP programming clock.
28	RB7/PGD	Digital I/O. In-circuit debugger and ICSP programming data.

**MICROCONTROLLER PROGRAMING**

PIC16F873A microcontroller used program code as given below

.....  
 .....

LIST P= PIC16F873A

INCLUDE "P16F873A.INC"

BANK0 EQU 20H

```

CBLOCK BANK0
LOWERLSB
HIGHER
UNIT
TEN
HUND
R1
R2
REQUEST
HEX
THOU
TEMP
DIGIT_SEL
DIGIT_DISP
DIGIT_OUT
REPEAT
ENDC
ORG 0X000
RVRESET
GOTO START
ORG 0X004
RVINT
BTFSS PIR1, ADIF
GOTO $-1
BCF PIR1, ADIF
CALL ADC_INT
GOTO PROGRAM
RETFIE

START
CALL SET_PORTS
MOVLW 0X0F
MOVWF REPEAT
GOTO PROGRAM

SET_PORTS
:CALL SET_PORTA
CALL SET_PORTB
CALL SET_PORTC
RETURN

SET_PORTA
BANKSEL ADCON1
MOVLW 0X06
MOVWF ADCON1
BANKSEL TRISA
MOVLW 0X3F
MOVWF TRISA
BANKSEL PORTA
CLRF PORTA
RETURN

SET_PORTB
BANKSEL TRISB
CLRF TRISB
BANKSEL PORTB
CLRF PORTB
RETURN

SET_PORTC
BANKSEL TRISC
CLRF TRISC
BANKSEL PORTC
CLRF PORTC
RETURN

PROGRAM
CALL SET_PORTB
CALL SET_PORTC
CALL HEX_TO_BCD
CALL NUMBER
CALL DISPLAY
DECFSZ REPEAT, F
    
```

GOTO \$-2	CLRF TRISA
MOVLW 0X0F	COMF TRISA, F
MOVWF REPEAT	CLRF ADRESL
CALL REQUEST_1	NOP
CALL ADC_1	NOP
GOTO PROGRAM	NOP
REQUEST_1	NOP
MOVLW 0X01	BANKSEL ADCON0
MOVWF REQUEST	MOVLW 0X05
RETURN	MOVWF ADCON0
REQUEST_2	GOTO \$
MOVLW 0X09	
MOVWF REQUEST	ADC_INT
RETURN	CALL LOW_1
REQUEST_3	CALL HIGH_1
MOVLW 0X11	RETURN
MOVWF REQUEST	LOW_1
RETURN	BANKSEL ADRESL
REQUEST_4	MOVF ADRESL, W
MOVLW 0X19	MOVWF LOWERLSB
MOVWF REQUEST	RETURN
RETURN	HIGH_1
ADC_1	BANKSEL ADRESH
MOVLW 0XC0	MOVF ADRESH, W
MOVWF INTCON	MOVWF HIGHER
MOVF REQUEST, W	MOVWF HEX
MOVWF ADCON0	RETURN
CLRF PORTA	OUTPUT
CLRF ADRESH	BANKSEL TRISB
BANKSEL PIE1	CLRF TRISB
CLRF PIE1	BANKSEL PORTB
BSF PIE1, ADIE	MOVF HIGHER, W
MOVLW 0X40	MOVWF PORTB
MOVWF ADCON1	RETURN

NUMBER		RLF HEX, F	
SWAPF UNIT, W		RLF UNIT, F	
ANDLW 0X0F		RLF HUND, F	
MOVWF TEN		CALL UNIT_5	
MOVLW 0X0F		CALL TEN_5	
ANDWF UNIT, F		BCF STATUS, 0	:8 shift
RETURN		RLF HEX, F	
HEX_TO_BCD		RLF UNIT, F	
BANKSEL STATUS		RLF HUND, F	
BCF STATUS, 0	:1 shift	RETURN	
RLF HEX, F		UNIT_5	
RLF UNIT, F		MOVF UNIT, W	
BCF STATUS, 0	:2 shift	ANDLW 0X0F	
RLF HEX, F		MOVWF TEMP	
RLF UNIT, F		MOVLW 0X05	
BCF STATUS, 0	:3 shift	SUBWF TEMP, W	
RLF HEX, F		BANKSEL STATUS	
RLF UNIT, F		BTFSS STATUS, 0	
CALL UNIT_5		RETURN	
BCF STATUS, 0	:4 shift	MOVLW 0X03	
RLF HEX, F		ADDWF UNIT, F	
RLF UNIT, F		RETURN	
CALL UNIT_5		TEN_5	
BCF STATUS, 0	:5 shift	MOVF UNIT, W	
RLF HEX, F		ANDLW 0XF0	
RLF UNIT, F		MOVWF TEMP	
CALL UNIT_5		MOVLW 0X50	
BCF STATUS, 0	:6 shift	SUBWF TEMP, W	
RLF HEX, F		BANKSEL STATUS	
RLF UNIT, F		BTFSS STATUS, 0	
CALL UNIT_5		RETURN	
CALL TEN_5		MOVLW 0X30	
		ADDWF UNIT, F	
BCF STATUS, 0	:7 shift	RETURN	

```

DISPLAY
    CLRF DIGIT_SEL
    BCF DIGIT_SEL, 7
    BSF DIGIT_SEL, 4
    MOVF UNIT, W
    MOVWF DIGIT_DISP
    CALL S_S_DECODER
    MOVWF DIGIT_OUT
    CALL DIGIT_SELECT
    CALL OUT_TO_FND
    CALL DELAY
    BCF DIGIT_SEL, 4
    BSF DIGIT_SEL, 5
    MOVF TEN, W
    MOVWF DIGIT_DISP
    CALL S_S_DECODER
    MOVWF DIGIT_OUT
    CALL DIGIT_SELECT
    CALL OUT_TO_FND
    CALL DELAY

    BCF DIGIT_SEL, 5
    BSF DIGIT_SEL, 6
    MOVF HUND, W
    MOVWF DIGIT_DISP
    CALL S_S_DECODER
    MOVWF DIGIT_OUT
    CALL DIGIT_SELECT
    CALL OUT_TO_FND
    CALL DELAY
    BCF DIGIT_SEL, 6
    BSF DIGIT_SEL, 7
    MOVF THOU, W
    MOVWF DIGIT_DISP

CALL S_S_DECODER
MOVWF DIGIT_OUT
CALL DIGIT_SELECT
CALL OUT_TO_FND
CALL DELAY
GOTO DISPLAY
RETURN

S_S_DECODER
;Display code table.....
MOVF DIGIT_DISP, W ; Get key count
ADDWF PCL ; and calculate jump
;NOP ; into table
RETLW B'11011110' ; Code for '0'
RETLW B'01000010' ; Code for '1'
RETLW B'11101100' ; Code for '2'
RETLW B'11100110' ; Code for '3'
RETLW B'01110010' ; Code for '4'
RETLW B'10110110' ; Code for '5'
RETLW B'10111110' ; Code for '6'
RETLW B'11000010' ; Code for '7'
RETLW B'11111110' ; Code for '8'
RETLW B'11110110' ; Code for '9'
;Output display code.....
RETURN

OUT_TO_FND
    MOVF DIGIT_OUT, W
    MOVWF PORTB
    RETURN

DIGIT_SELECT
    CLRF PORTB
    MOVF DIGIT_SEL, W
    MOVWF PORTC
    RETURN

DELAY
    
```

```
MOVLW 0X0F
MOVWF R1
MOVWF R2
DECFSZ R2, F
GOTO $-1
DECFSZ R1, F
GOTO $-4
RETURN
```

DELAY\_L

```
MOVLW 0XFF
MOVWF R1
MOVWF R2
DECFSZ R2,F
GOTO $-1
DECFSZ R1,F
GOTO $-4
RETURN
END
```

### 3. MEASUREMENT OF ELECTROLUMINESCENCE (EL)

For the measurement of EL brightness EL cell is prepared by selected method and it is ready to use for measurement of luminescence. In prepared cell, there are two electrodes, one from conducting glass plate and other from phosphor sample side. Frequency is applied to amplifier at the desired level and it increases voltage up to required level, when frequency and voltage are reached at certain level, then emission of EL is takes place the emission of light is connected to Photomultiplier tube (PMT) and it converts the light in the form of current and then converted to voltage by voltage to current converter. The output voltage is apply to PIC16F873A microcontroller and it convert this analog voltage to Digital voltage. The digital voltage to be interfaced with the computer by parallel port. The data of parallel port is read by VB.NET software and finally luminescence of EL cell is converted in voltage, and is obtained at the screen of the computer.



Figure 1 Sample of Interfacing Window

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